

*Paragon Semiconductor Lighting Technology*

*PSLT*

**ParagonLED**

## Specifications

**Product Type : G2C000100-230V18WC30**

**Issued Date : 06/06/2014**

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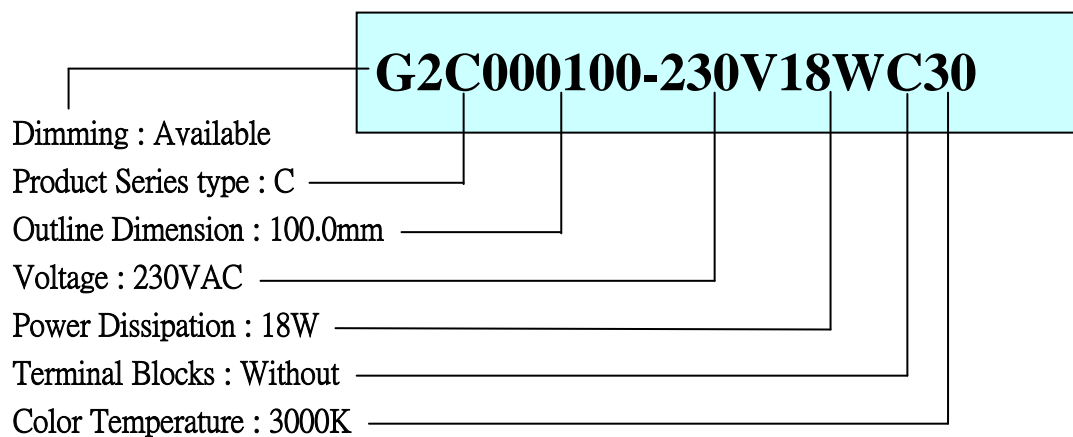
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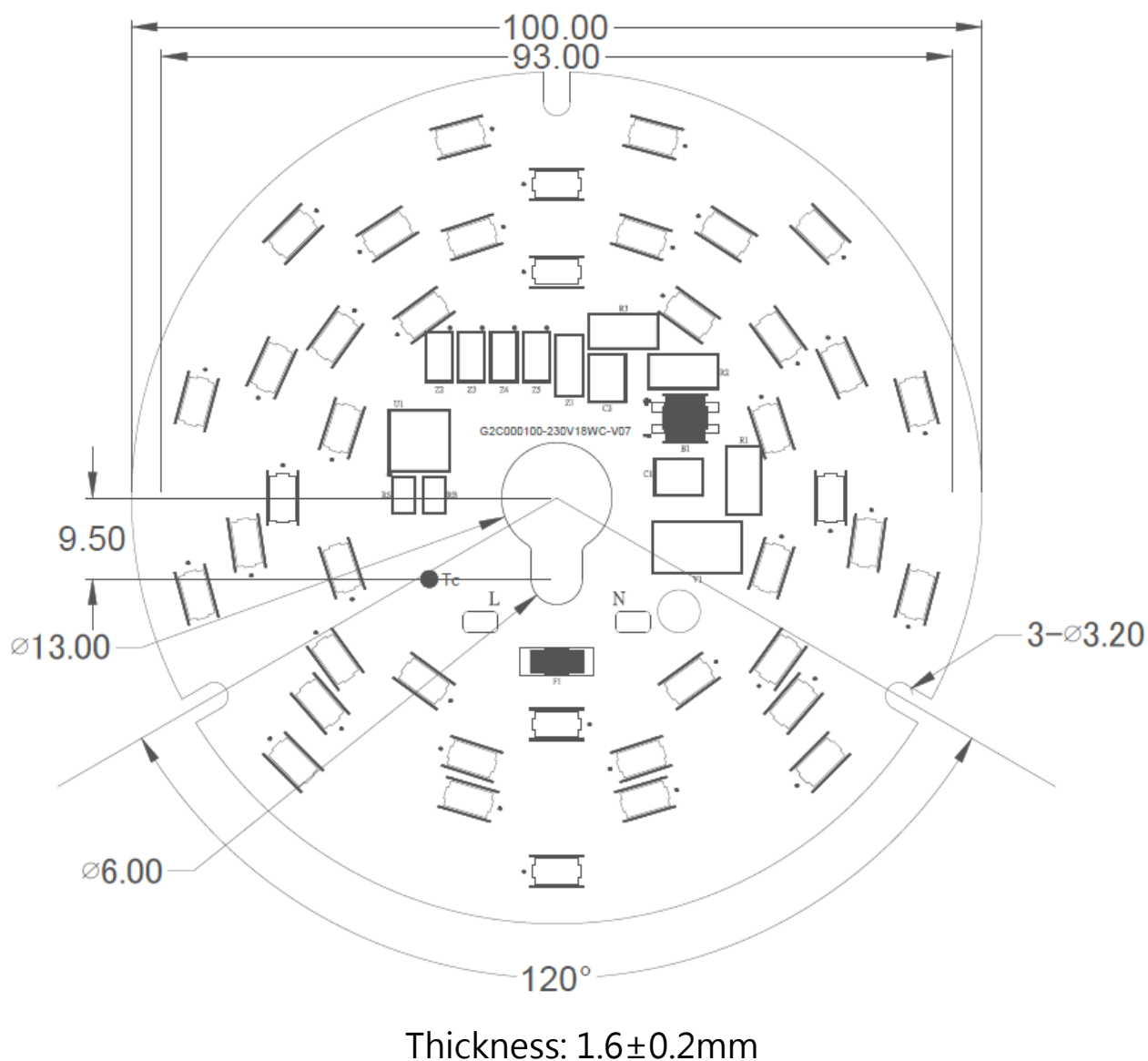
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# 1.General Description

## (1)Naming rule



## (2)Outline Dimensions (Unit : mm / Tolerance: 0.2mm)



## 2.Electro-Optical Characteristics

### (1)Absolute Maximum Rating

| Parameter                    | Symbol    | Value           | Unit |
|------------------------------|-----------|-----------------|------|
| Power Dissipation            | $P_D$     | 18              | W    |
| Forward Voltage              | $V_F$     | 230             | V    |
| Operating Temperature        | $T_{opr}$ | -40 ~ +105      | °C   |
| Storage Temperature          | $T_{stg}$ | -40 ~ +105      | °C   |
| Power Factor                 | Pf        | >0.95           |      |
| THDi                         |           | <15%            |      |
| Dimming                      |           | Available       |      |
| Assembly process temperature | $T_{sol}$ | <325°C , 5 secs |      |

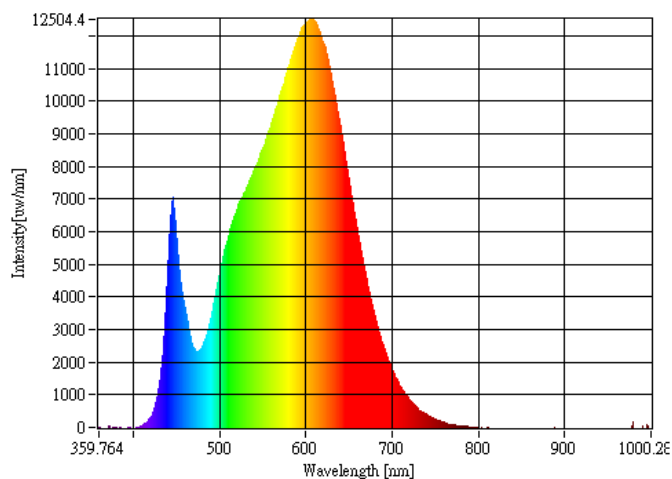
### (2)Electro-Optical Characteristics

| Parameter          | Symbol   | Condition  | Min | Typ  | Max | Unit    |
|--------------------|----------|------------|-----|------|-----|---------|
| Forward Voltage    | $V_F$    | —          | —   | 230  | —   | V       |
| Reverse Current    | $I_R$    | $V_R=230V$ | —   | —    | 20  | $\mu A$ |
| Luminous Intensity | $\Phi_v$ | $V_F=230V$ | —   | 1585 | —   | Lm      |
| Color rendering    | Ra       | $V_F=230V$ | —   | 80   | —   | CRI     |

**Notice: Operating Voltage of product varies from 220V~250V · users must keep the temperature of solder joint point under 105 °C (with suitable heat sink), or may cause Serious luminous decay. We DO NOT guarantee of improper use.**

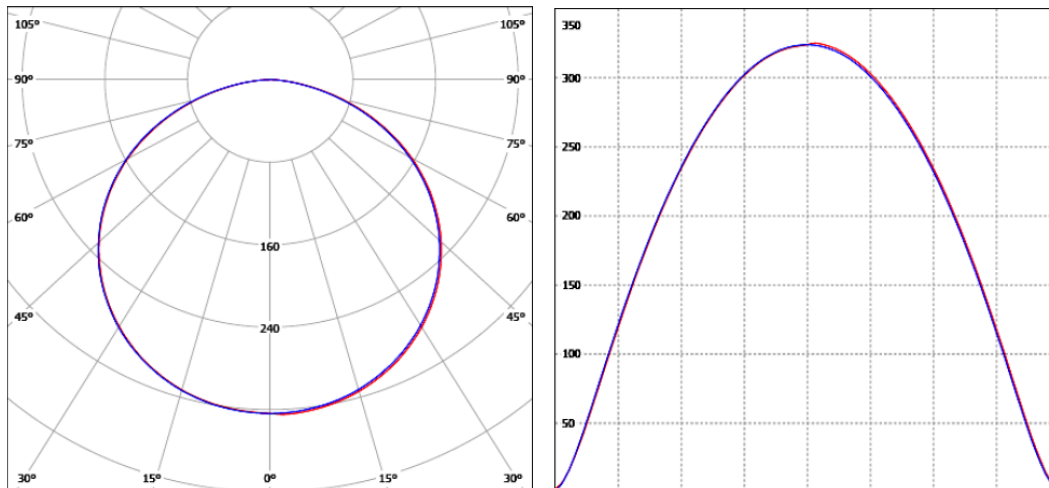
### (3) Graphs

 **Spectrum**

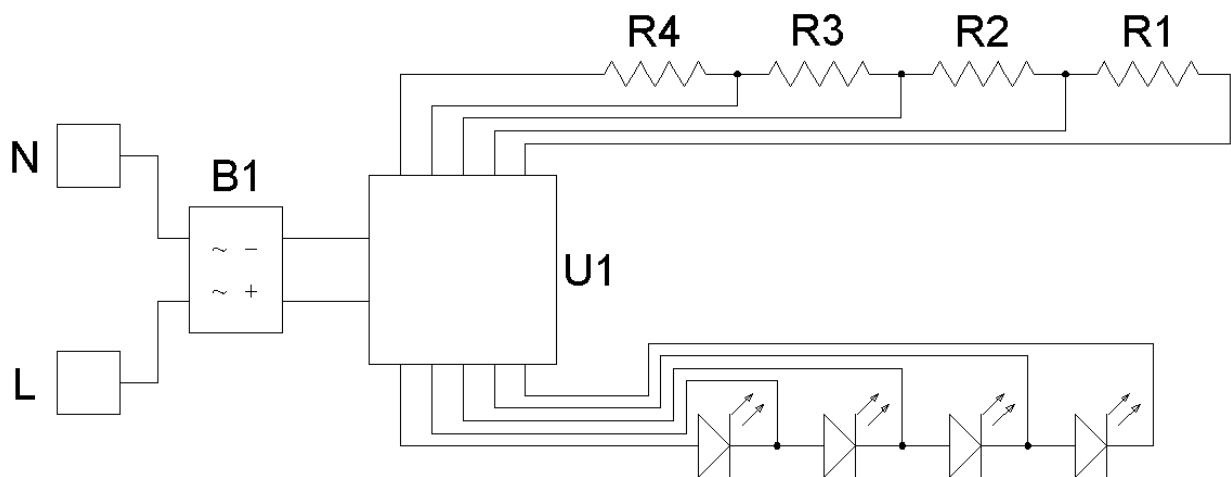




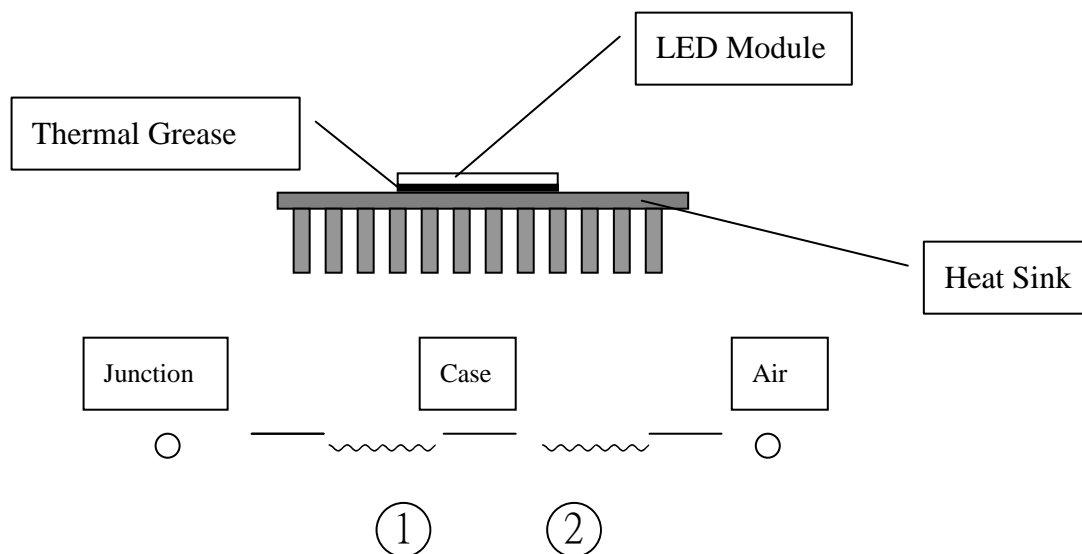
## Candle Power Distribution & Cartesian Coordinate



### (4)Layout



### 3. Junction Temperature Measurement



- ① Thermal resistance of Junction to Case without heat sink :  $10^{\circ}\text{C/W}$  [ Reference Value ]
- ② Thermal resistance of Case to Ambient Air: Depending on what kind of heat sink users choose. In ideal thermal dissipation situation, the thermal resistance is about  $1\sim 2^{\circ}\text{C/W}$ .

### 4. Reliability Test

| Test Item                     | Test Conditions   | Number of failed |
|-------------------------------|---|------------------|
| High Temperature Storage Test | Tstg= $+80^{\circ}\text{C}$ , x1,000 hrs                                    | 0/20             |
| Low Temperature Storage Test  | Tstg= $-40^{\circ}\text{C}$ , x1,000 hrs                                    | 0/20             |
| Continous Light-on Test       | Ta= $25^{\circ}\text{C}$ , RH=65%, x1,000 hrs                               | 0/20             |
| Boiling Test                  | Ta= $100^{\circ}\text{C}$ , RH=100%, x180mins                               | 0/20             |
| Thermal Cycle Test            | $-40^{\circ}\text{C}$ x 30 mins, $80^{\circ}\text{C}$ x 30 mins, 100 cycles | 0/20             |

| Measuring Item      | Measuring Condition | Judging Criteria of Failure |
|---------------------|---------------------|-----------------------------|
| Forward Voltage     | $I_F = 230\text{V}$ | $> 0 \times 1.1$            |
| Total Luminous Flux | $I_F = 230\text{V}$ | $< L \times 0.7$            |